Product data sheet

1. General description

Silicon Carbide Schottky Diode in 2-lead TO247-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- New 6th Generation Technology
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- High Forward Surge Capability IFSM
- Reduced Losses in Associated MOSFET
- Reduced EMI
- Reduced Cooling Requirements
- RoHS Compliant

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter Conditions		Values				Unit	
Absolute	Absolute maximum rating							
V_{RRM}	repetitive peak reverse voltage	e peak reverse 650		V				
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 132 °C; Fig. 1; Fig. 2; Fig. 3	20			А		
T _j	junction temperature		175			°C		
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit		
Static ch	Static characteristics							
V_{F}	forward voltage	I _F = 20 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.22	1.4	V	
		I _F = 20 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.3	1.5	V	
Dynamic	Dynamic characteristics							
Q _r	$I_F = 20 \text{ A}; dI_F/dt = 500 \text{ A/}\mu\text{s}; V_R = T_j = 25 \text{ °C}; Fig. 7$			-	65	-	nC	

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		1/ 1/4 A
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathode	K A TO247-2L	

6. Ordering information

Table 3. Ordering information

Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	name		method	quantity	version	issue date
WNSC6D20650W	TO247-2L	WNSC6D20650WQ	Tube	30	TO247L-2L	10-Nov-2020

7. Marking

Table 4. Marking codes

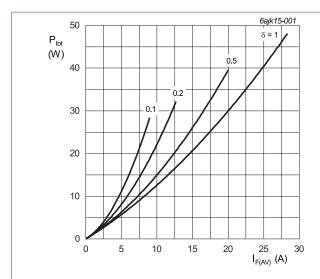
Type number	Marking codes
WNSC6D20650W	WNSC6D 20650W

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		650	V
V_{RWM}	crest working reverse voltage		650	V
V_R	reverse voltage	DC	650	V
I _{F(AV)}	average forward current	$δ$ = 0.5; square-wave pulse; $T_{mb} \le 132$ °C; Fig. 1; Fig. 2; Fig. 3	20	А
I _{FRM}	repetitive peak forward current	$δ = 0.5$; $t_p = 25 \mu s$; $T_{mb} \le 132 °C$; square-wave pulse	40	А
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	155	А
	forward current	t_p = 10 μs; $T_{j(init)}$ = 25 °C; square-wave pulse	1250	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	120	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ $V_o = 1.019 \text{ V}; R_s = 0.0239 \Omega$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

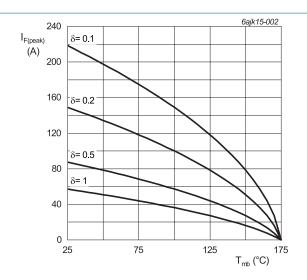
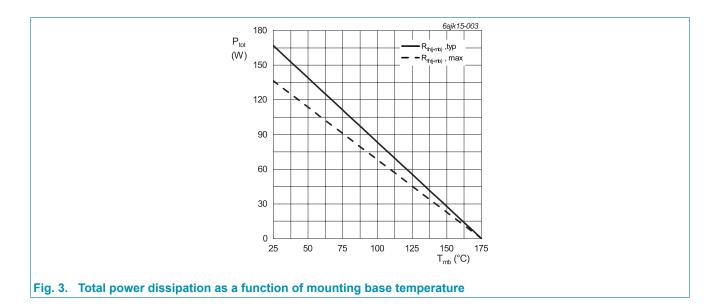


Fig. 2. Current derating as a function of mounting base temperature



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 4	-	0.9	1.1	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

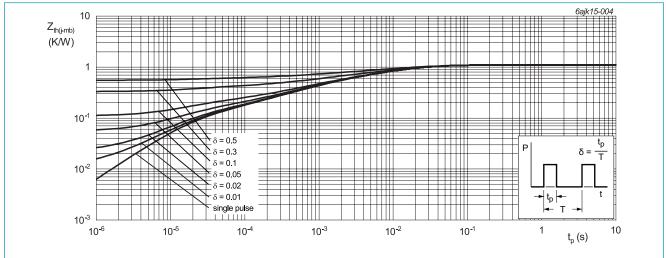
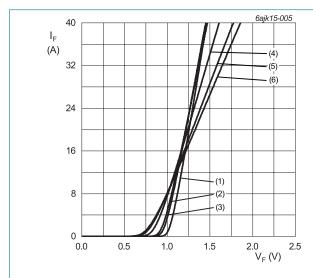


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V_{F}	forward current	I _F = 20 A; T _j = 25 °C; <u>Fig. 5</u>	-	-	1.22	1.4	V
		I _F = 20 A; T _j = 150 °C; <u>Fig. 5</u>	-	-	1.3	1.5	V
		I _F = 20 A; T _j = 175 °C; <u>Fig. 5</u>	-	•	1.34	1.6	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C; <u>Fig. 6</u>	-	•	5	100	μA
		V _R = 650 V; T _j = 175 °C; <u>Fig. 6</u>	-	-	30	200	μA
Dynamic	characteristics		'				
Q _r	recovered charge	$I_F = 20 \text{ A}$; $V_R = 400 \text{ V}$; $dI_F/dt = 500 \text{ A/µs}$; $T_j = 25 \text{ °C}$; Fig. 7	-	-	65	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	-	1200	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	-	135	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	-	110	-	pF
E _{as}	non-repetitive avalanche energy	$I_R = 8.2 \text{ A}$; L = 5 mH; $T_{j(init)} = 25 \text{ °C}$	1	168	-	-	mJ



 $V_o = 1.019 \text{ V}; R_s = 0.0239 \Omega$

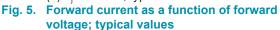
(1) $T_j = -55$ °C; typical values (2) $T_j = 0$ °C; typical values

(3) T_i = 25 °C; typical values

(4) T_i = 100 °C; typical values

(5) T_i = 150 °C; typical values

(6) T_i = 175 °C; typical values



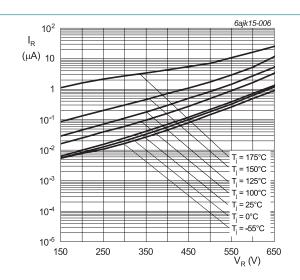


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value

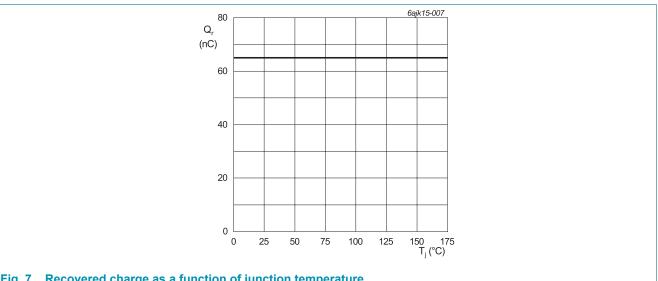
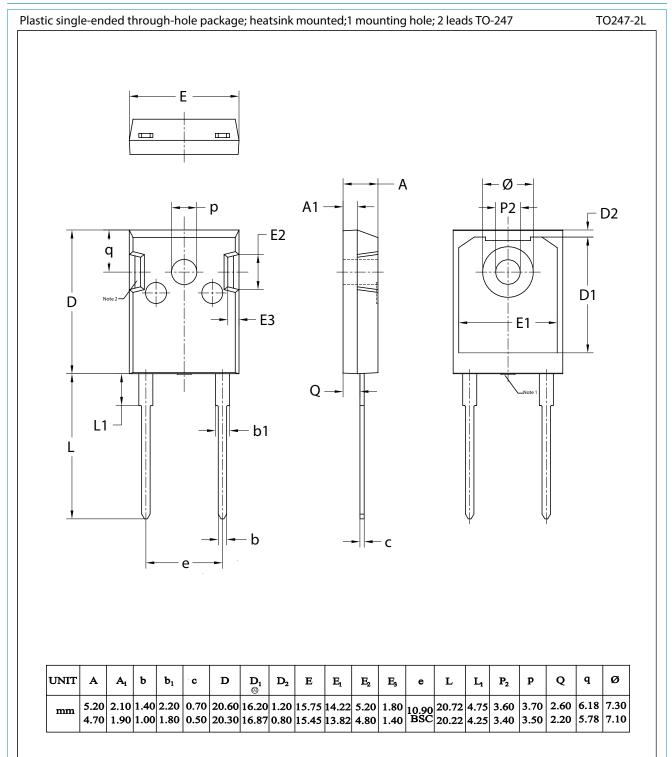


Fig. 7. Recovered charge as a function of junction temperature

11. Package outline



Note:

- 1. Mold resin protrusion max 0.127mm.
- 2. Metal exposed with Sn plating.

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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